



224 B These assemblies must comply with workmanship standards (IPC-A-610 Class 2, unless otherwise specified).  
225 B These assemblies must be clean and free from dust and all contaminants. Use of an clean flux is not acceptable.  
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COMPONENTS MARKED "DNP" SHOULD NOT BE POPULATED.  
ASSEMBLY VARIANTS (No Variations)

PCB VIEWED FROM TOP SIDE	BOMID R: TTDN-01012-HV DEV EI	SUN REV: 6965 (Locally Modified)
PLOT NAME = Top Assembly Drawing	GENERATED : 03-06-2026 16:15:47	TEXAS INSTRUMENTS

